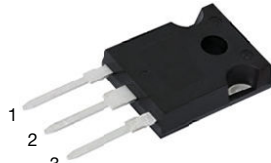
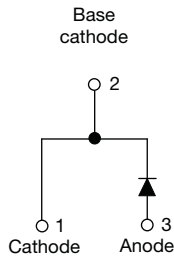
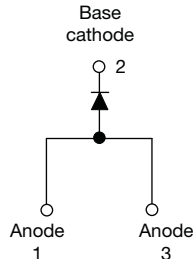


Fast Soft Recovery Rectifier Diode, 30 A


TO-247AC 2L

TO-247AC 3L

VS-30EPF0...

VS-30APF0...

FEATURES

- Glass passivated pellet chip junction
- 150 °C max. operating junction temperature
- Low forward voltage drop and short reverse recovery time
- Designed and qualified according to JEDEC®-JESD 47
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
 COMPLIANT
 HALOGEN
FREE
 Available

APPLICATIONS

These devices are intended for use in output rectification and freewheeling in inverters, choppers and converters as well as in input rectification where severe restrictions on conducted EMI should be met.

DESCRIPTION

The VS-30EPF06-M3 and VS-30APF06-M3 soft recovery rectifier series has been optimized for combined short reverse recovery time and low forward voltage drop.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	30 A
V_R	200 V, 400 V, 600 V
V_F at I_F	1.41 V
I_{FSM}	320 A
t_{rr}	60 ns
T_J max.	150 °C
Package	TO-247AC 2L, TO-247AC 3L
Circuit configuration	Single
Snap factor	0.6

MAJOR RATINGS AND CHARACTERISTICS			
SYMBOL	CHARACTERISTICS	VALUES	UNITS
$I_{F(AV)}$	Sinusoidal waveform	30	A
V_{RRM}		200 to 600	V
I_{FSM}		320	A
V_F	10 A, $T_J = 25$ °C	1.2	V
t_{rr}	1 A, 100 A/μs	60	ns
T_J		-40 to +150	°C

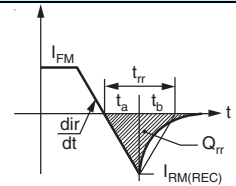
VOLTAGE RATINGS			
PART NUMBER	V_{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V	V_{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V	I_{RRM} AT 150 °C mA
VS-30EPF02-M3, VS-30APF02-M3	200	300	5
VS-30EPF04-M3, VS-30APF04-M3	400	500	
VS-30EPF06-M3, VS-30APF06-M3	600	700	



ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum average forward current	$I_{F(AV)}$	$T_C = 98\text{ }^\circ\text{C}$, 180° conduction half sine wave		30	A
Maximum peak one cycle non-repetitive surge current	I_{FSM}	10 ms sine pulse, rated V_{RRM} applied		270	
		10 ms sine pulse, no voltage reapplied		320	
Maximum I^2t for fusing	I^2t	10 ms sine pulse, rated V_{RRM} applied		365	A^2s
		10 ms sine pulse, no voltage reapplied		515	
Maximum $I^2\sqrt{t}$ for fusing	$I^2\sqrt{t}$	$t = 0.1\text{ ms to }10\text{ ms}$, no voltage reapplied		5150	$A^2\sqrt{s}$

ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum forward voltage drop	V_{FM}	30 A, $T_J = 25\text{ }^\circ\text{C}$		1.41	V
Forward slope resistance	r_t	$T_J = 150\text{ }^\circ\text{C}$		12.5	$m\Omega$
Threshold voltage	$V_{F(TO)}$			0.9	V
Maximum reverse leakage current	I_{RM}	$T_J = 25\text{ }^\circ\text{C}$	$V_R = \text{Rated } V_{RRM}$	0.1	mA
		$T_J = 150\text{ }^\circ\text{C}$		5.0	

RECOVERY CHARACTERISTICS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Reverse recovery time	t_{rr}	I_F at 20 A _{pk} 100 A/ μ s 25 °C	160	ns
Reverse recovery current	I_{rr}		10	A
Reverse recovery charge	Q_{rr}		1.25	μ C
Snap factor	S	Typical	0.6	



THERMAL - MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum junction and storage temperature range	T_J, T_{Stg}			-40 to +150	$^\circ\text{C}$
Maximum thermal resistance, junction to case	R_{thJC}	DC operation		0.8	$^\circ\text{C/W}$
Maximum thermal resistance, junction to ambient	R_{thJA}			40	
Maximum thermal resistance, case to heatsink	R_{thCS}	Mounting surface, smooth and greased		0.2	
Approximate weight				6	g
				0.21	oz.
Mounting torque	minimum			6 (5)	$\text{kgf} \cdot \text{cm}$ ($\text{lbf} \cdot \text{in}$)
	maximum			12 (10)	
Marking device		Case style TO-247AC 2L		30EPF02	
				30EPF04	
				30EPF06	
		Case style TO-247AC 3L		30APF02	
				30APF04	
				30APF06	

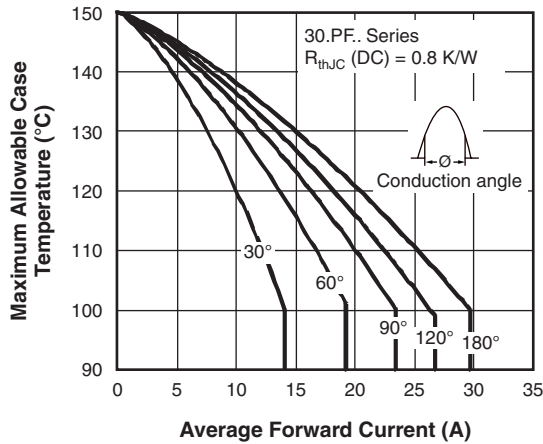


Fig. 1 - Current Rating Characteristics

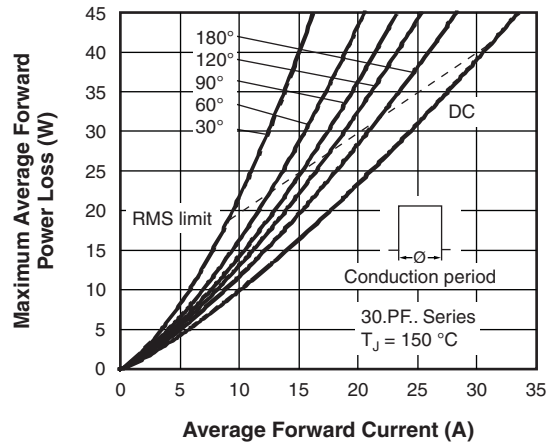


Fig. 4 - Forward Power Loss Characteristics

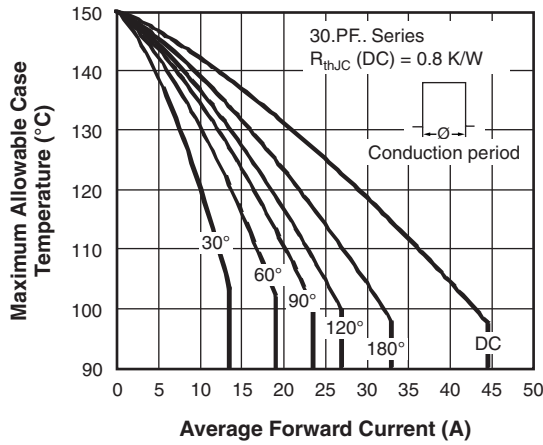


Fig. 2 - Current Rating Characteristics

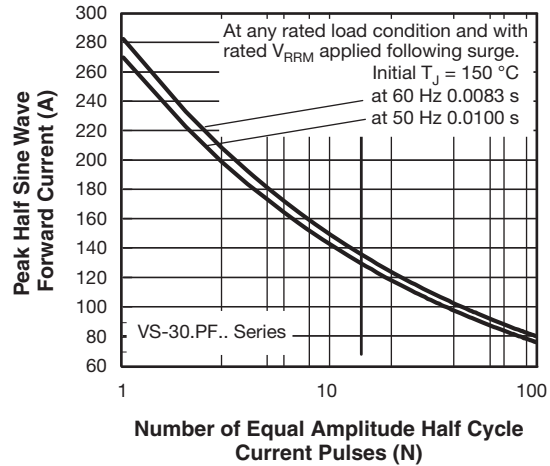


Fig. 5 - Maximum Non-Repetitive Surge Current

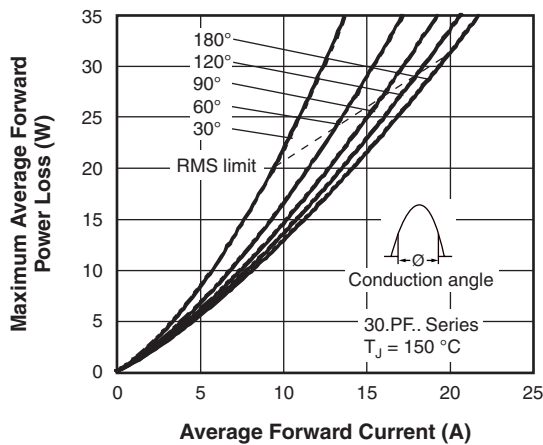


Fig. 3 - Forward Power Loss Characteristics

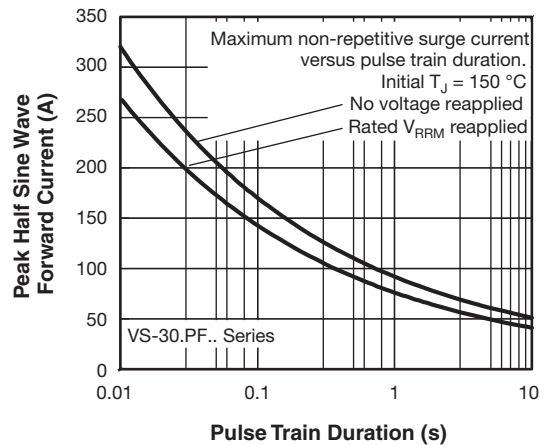


Fig. 6 - Maximum Non-Repetitive Surge Current

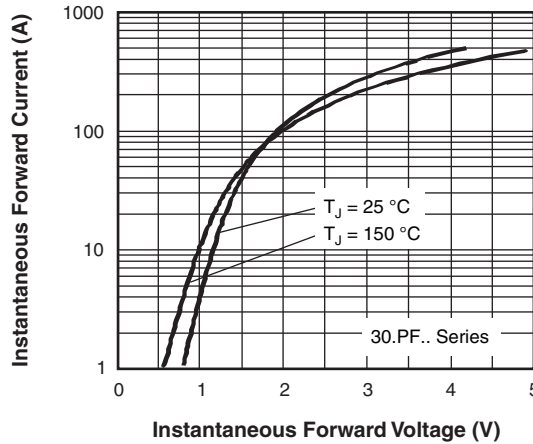


Fig. 7 - Forward Voltage Drop Characteristics

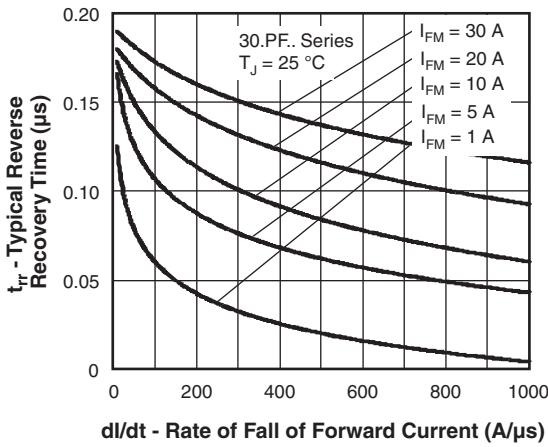


Fig. 8 - Recovery Time Characteristics, $T_J = 25\text{ }^\circ\text{C}$

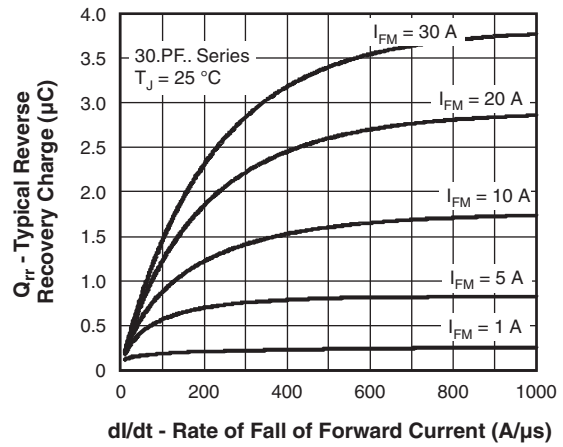


Fig. 10 - Recovery Charge Characteristics, $T_J = 25\text{ }^\circ\text{C}$

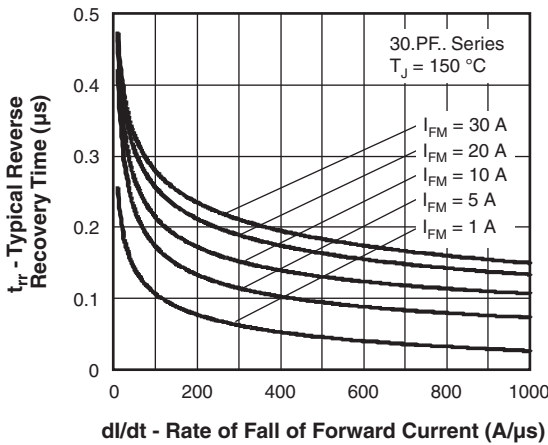


Fig. 9 - Recovery Time Characteristics, $T_J = 150\text{ }^\circ\text{C}$

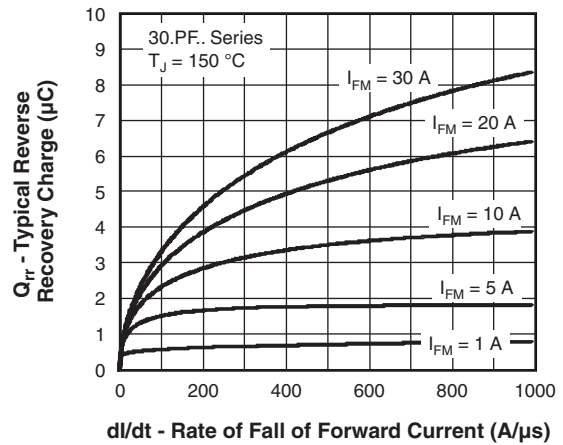


Fig. 11 - Recovery Charge Characteristics, $T_J = 150\text{ }^\circ\text{C}$

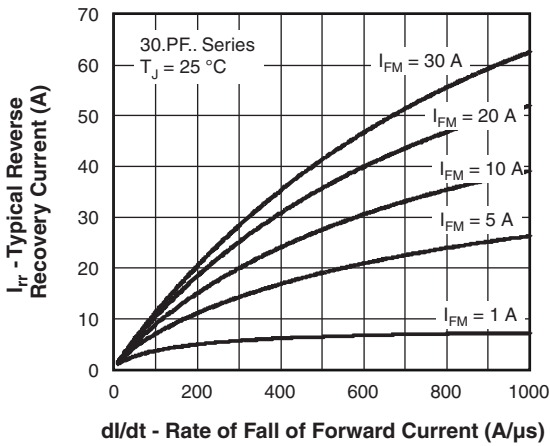


Fig. 12 - Recovery Current Characteristics, $T_J = 25\text{ }^\circ\text{C}$

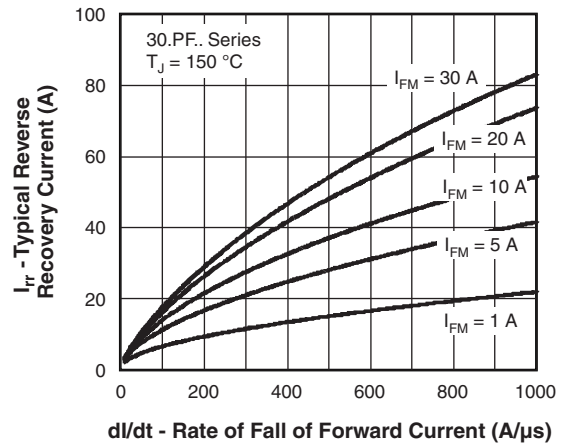


Fig. 13 - Recovery Current Characteristics, $T_J = 150\text{ }^\circ\text{C}$

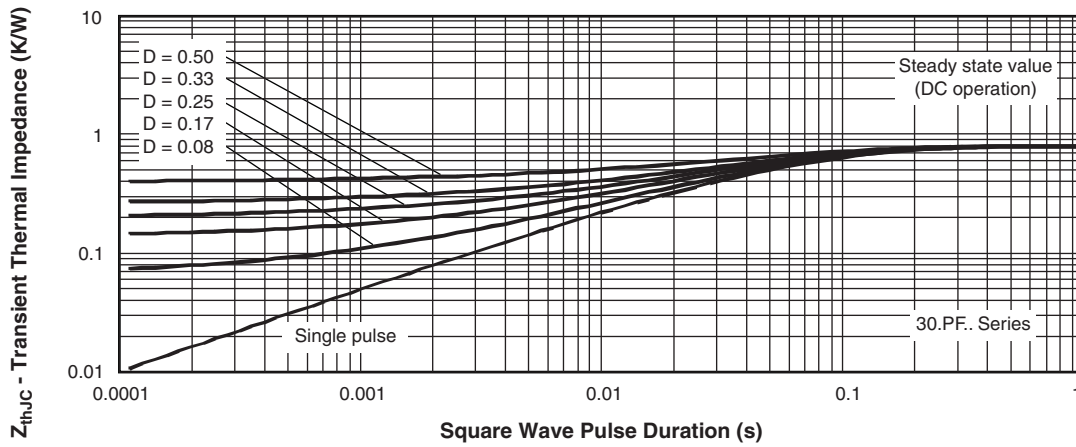
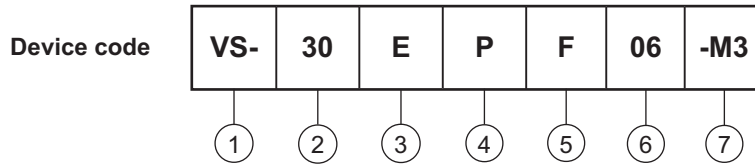


Fig. 14 - Thermal Impedance Z_{thJC} Characteristics



ORDERING INFORMATION TABLE



- 1** - Vishay Semiconductors product
- 2** - Current rating (30 = 30 A)
- 3** - Circuit configuration:
E = single diode, 2 pins
A = single diode, 3 pins
- 4** - Package:
P = TO-247AC 3L / TO-247AC 2L
- 5** - Type of silicon:
F = fast recovery
- 6** - Voltage code x 100 = V_{RRM}

02 = 200 V
04 = 400 V
06 = 600 V
- 7** - Environmental digit:
-M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

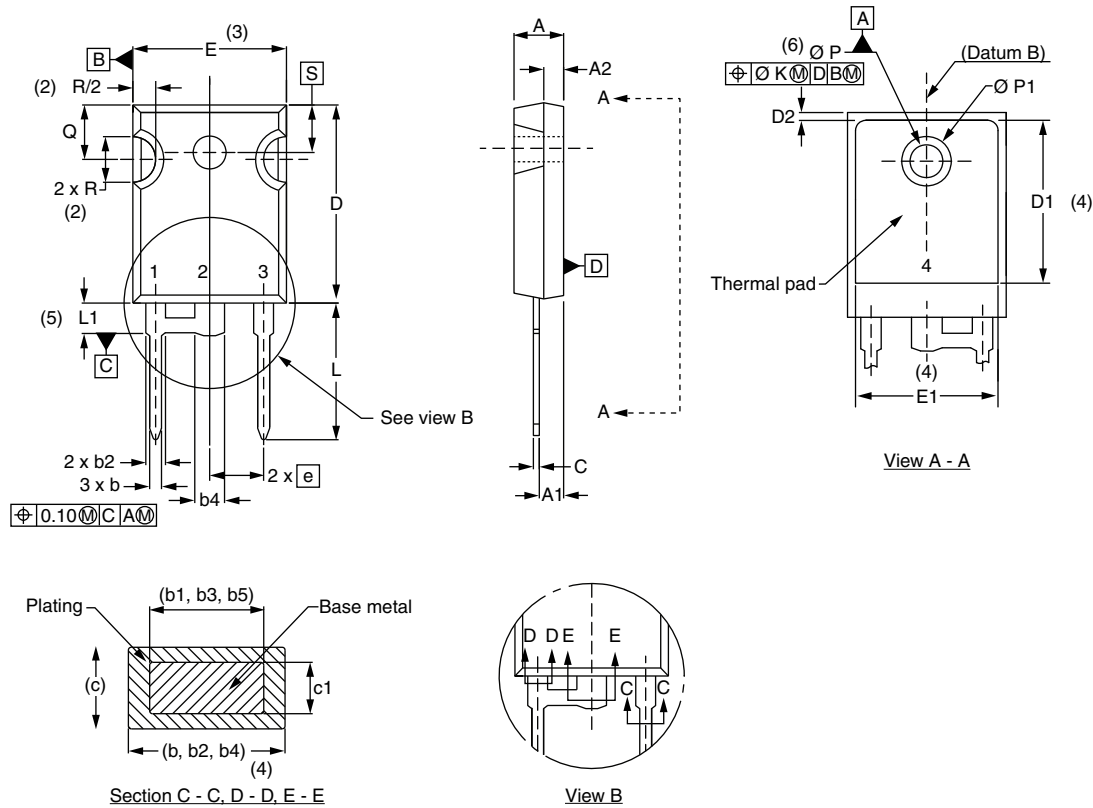
ORDERING INFORMATION (Example)			
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-30EPF02-M3	25	500	Antistatic plastic tubes
VS-30APF02-M3	25	500	Antistatic plastic tubes
VS-30EPF04-M3	25	500	Antistatic plastic tubes
VS-30APF04-M3	25	500	Antistatic plastic tubes
VS-30EPF06-M3	25	500	Antistatic plastic tubes
VS-30APF06-M3	25	500	Antistatic plastic tubes

LINKS TO RELATED DOCUMENTS		
Dimensions	TO-247AC 2L	www.vishay.com/doc?96144
	TO-247AC 3L	www.vishay.com/doc?96138
Part marking information	TO-247AC 2L	www.vishay.com/doc?95648
	TO-247AC 3L	www.vishay.com/doc?95007



TO-247AC modified - 50 mils L/F

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES	SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.			MIN.	MAX.	MIN.	MAX.	
A	4.65	5.31	0.183	0.209		D2	0.51	1.35	0.020	0.053	
A1	2.21	2.59	0.087	0.102		E	15.29	15.87	0.602	0.625	3
A2	1.17	1.37	0.046	0.054		E1	13.46	-	0.53	-	
b	0.99	1.40	0.039	0.055		e	5.46 BSC		0.215 BSC		
b1	0.99	1.35	0.039	0.053		ΦK	0.254		0.010		
b2	1.65	2.39	0.065	0.094		L	14.20	16.10	0.559	0.634	
b3	1.65	2.34	0.065	0.092		L1	3.71	4.29	0.146	0.169	
b4	2.59	3.43	0.102	0.135		ΦP	3.56	3.66	0.14	0.144	
b5	2.59	3.38	0.102	0.133		$\Phi P1$	-	7.39	-	0.291	
c	0.38	0.89	0.015	0.035		Q	5.31	5.69	0.209	0.224	
c1	0.38	0.84	0.015	0.033		R	4.52	5.49	0.178	0.216	
D	19.71	20.70	0.776	0.815	3	S	5.51 BSC		0.217 BSC		
D1	13.08	-	0.515	-	4						

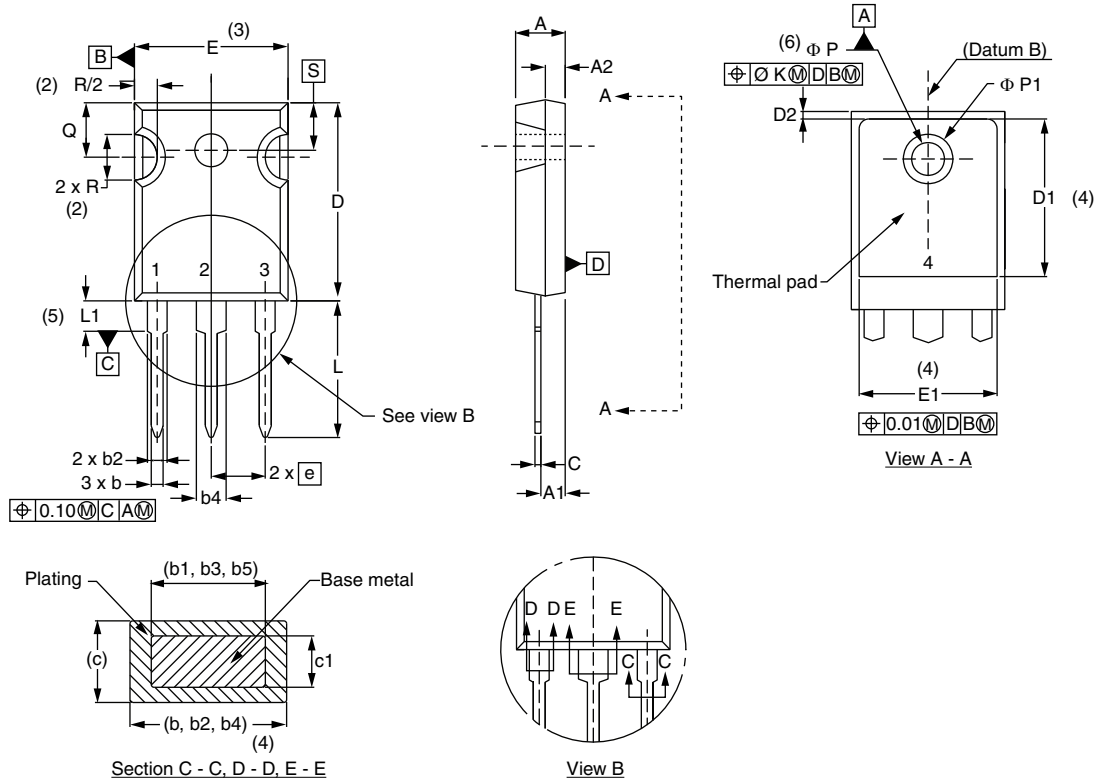
Notes

- (1) Dimensioning and tolerance per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) ΦP to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension c and Q



TO-247AC - 50 mils L/F

DIMENSIONS in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES	SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.			MIN.	MAX.	MIN.	MAX.	
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A2	1.17	1.37	0.046	0.054		E1	13.46	-	0.53	-	
b	0.99	1.40	0.039	0.055		e	5.46 BSC		0.215 BSC		
b1	0.99	1.35	0.039	0.053		Ø K	0.254		0.010		
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